THE DATASHEET OF

DT1042-04SO-7

4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

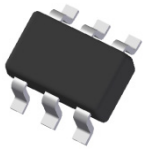
Features

- Low Clamping Voltage, I/O to V_{SS}
- Typical 9V at 10A 100ns, TLP
- Typical 7.7V at 6A 8µs/20µs
- IEC 61000-4-2 (ESD): Air – +27/-19kV, Contact – ±16kV
- IEC 61000-4-4 (EFT): Level-4
- IEC 61000-4-5 (Lightning): ±6A
- 4 Channels of ESD protection
- Low Channel Input Capacitance of 0.65pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Typically Used for High Speed Ports such as USB 2.0, IEEE1394, HDMI, Laptop and Personal Computers, Flat Panel Displays, Video Graphics Displays, SIM Ports
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

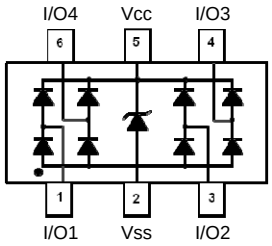
Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe
- (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.016 grams (approximate)

SOT26



Top View



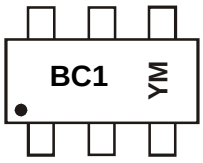
Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DT1042-04SO-7	Standard	BC1	7	8	3,000/Tape & Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



BC1 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: A = 2013)
M = Month (ex: 9 = September)

Date Code Key

Year	2013	2014	2015	2016	2017	2018
Code	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	$I_{PP\_I/O}$	±6	A	I/O to V_{SS}, 8/20 µs
Peak Pulse Power, per IEC 61000-4-5	$P_{PP\_I/O}$	55	W	I/O to V_{SS}, 8/20 µs
Operating Voltage (DC)	V_{DC}	5.5	V	I/O to V_{SS}
ESD Protection – Contact Discharge, per IEC 61000-4-2	$V_{ESD\_I/O}$	±16	kV	I/O to V_{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	$V_{ESD\_I/O}$	+27/-19	kV	I/O to V_{SS}
Operating Temperature	T_{OP}	-55 to +85	°C	___
Storage Temperature	T_{STG}	-55 to +150	°C	___

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P_D	300	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{\theta JA}$	417	°C/W

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	—	—	5.0	V	V_{CC} to V_{SS}
Reverse Current (Note 6)	$I_{R(Vcc\ to\ Vss)}$	—	—	1.0	µA	$V_R = V_{RWM}$ = 5V, V_{CC} to V_{SS}
Reverse Current (Note 6)	$I_{R(IO\ to\ Vss)}$	—	—	0.5	µA	$V_R = V_{RWM}$ = 5V, any I/O to V_{SS}
Reverse Breakdown Voltage	V_{BR}	6.2	—	—	V	I_R = 1mA, V_{CC} to V_{SS}
Forward Clamping Voltage	V_F	-1.0	-0.8	—	V	I_F = -15mA, V_{CC} to V_{SS}
Reverse Clamping Voltage(Note 7)	V_{C_Vcc}	—	6.3	—	V	I_{PP} = 9A, V_{CC} to V_{SS}, 8/20 µs
	$V_{C\_I/O}$	—	7.7	9	V	I_{PP} = 6A, I/O to V_{SS}, 8/20 µs
ESD Clamping Voltage	V_{ESD_Vcc}	—	6.8	—	V	TLP, 10A, tp = 100 ns, V_{CC} to V_{SS}, per Fig. 8
	$V_{ESD\_I/O}$	—	9	—	V	TLP, 10A, tp = 100 ns, I/O to V_{SS}, per Fig. 8
Dynamic Resistance	R_{DIF_Vcc}	—	0.1	—	Ω	TLP, 10A, tp = 100 ns, V_{CC} to V_{SS}
	$R_{DIF\_I/O}$	—	0.25	—	Ω	TLP, 10A, tp = 100 ns, I/O to V_{SS}
Channel Input Capacitance	$C_{I/O\ to\ VSS}$	—	0.65	0.8	pF	V_R = 2.5V, V_{CC} = 5V, f = 1MHz
Variation of Channel Input Capacitance	$\Delta C_{I/O}$	—	0.02	—	pF	V_{CC} = 5V, V_{SS} = 0V, I/O = 2.5V, f =1MHz, T=+25°C , I/O_x to V_{SS} – I/O_y to V_{SS}

Notes:
5. Device mounted on Polymide PCB pad layout (2oz copper) as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
6. Short duration pulse test used to minimize self-heating effect.
7. Clamping voltage value is based on an 8x20µs peak pulse current (I_{pp}) waveform.

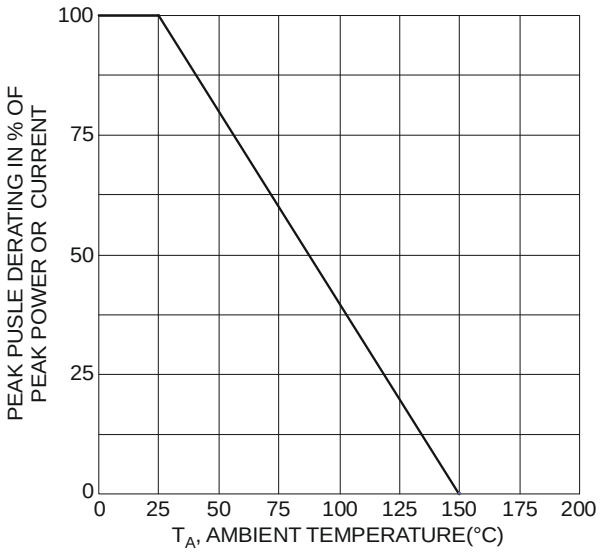


Figure 1 Pulse Derating Curve

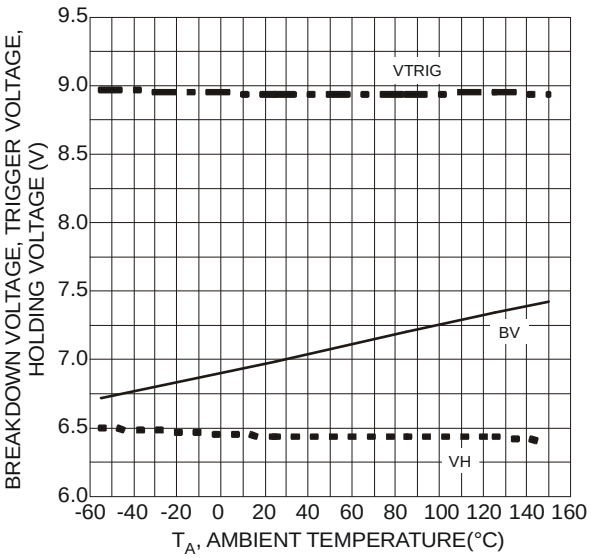


Figure 2 Breakdown Voltage, Trigger Voltage, Holding Voltage vs. Ambient Temperature

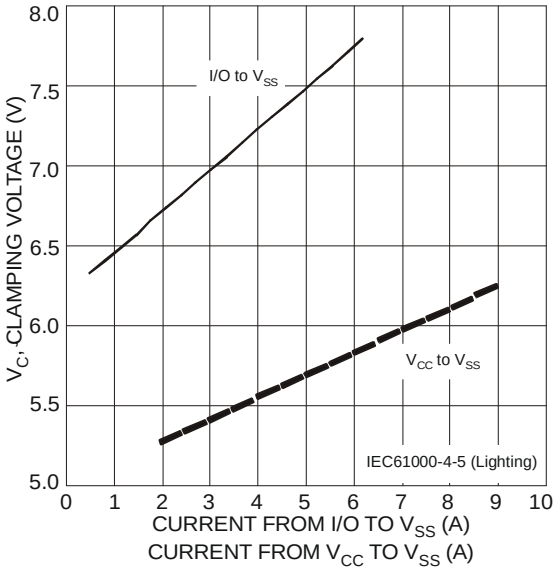


Figure 3 Clamping Voltage Characteristics

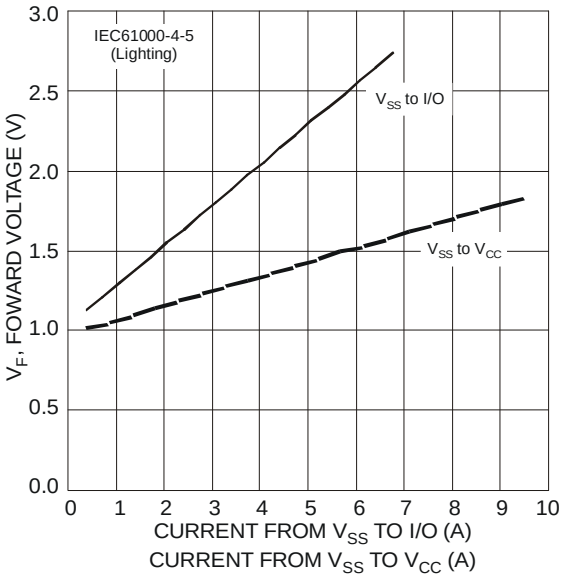


Figure 4 Forward Voltage Characteristics

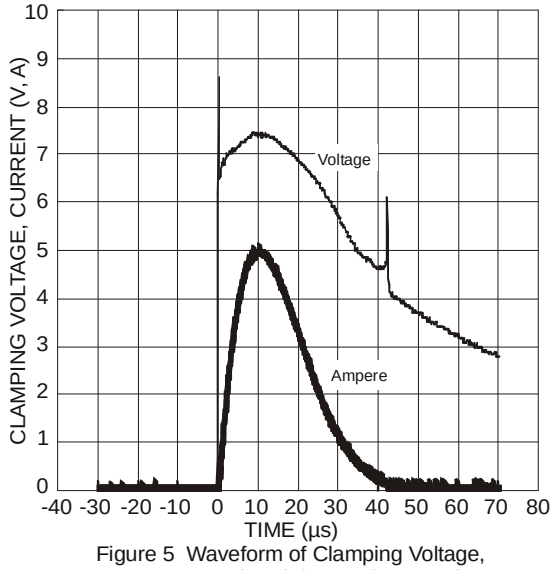


Figure 5 Waveform of Clamping Voltage, Current vs. Time (8/20µs, I/O to V_{SS})

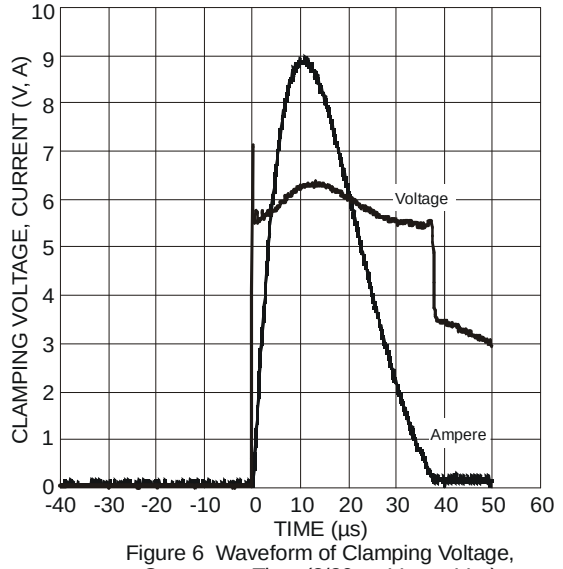


Figure 6 Waveform of Clamping Voltage, Current vs. Time (8/20µs, V_{CC} to V_{SS})

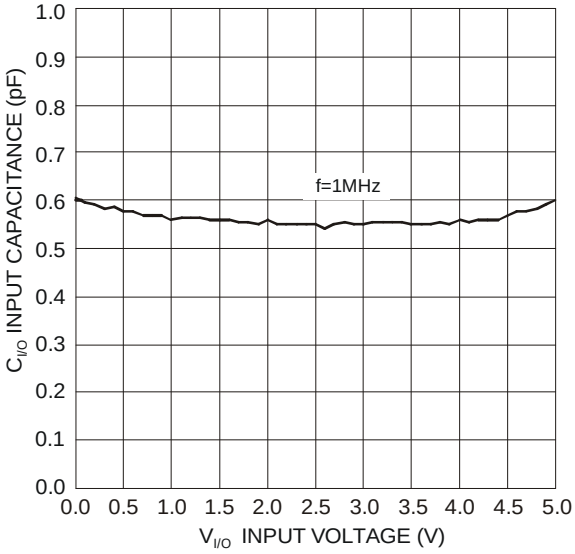


Figure 7 Input Capacitance vs. Input Voltage

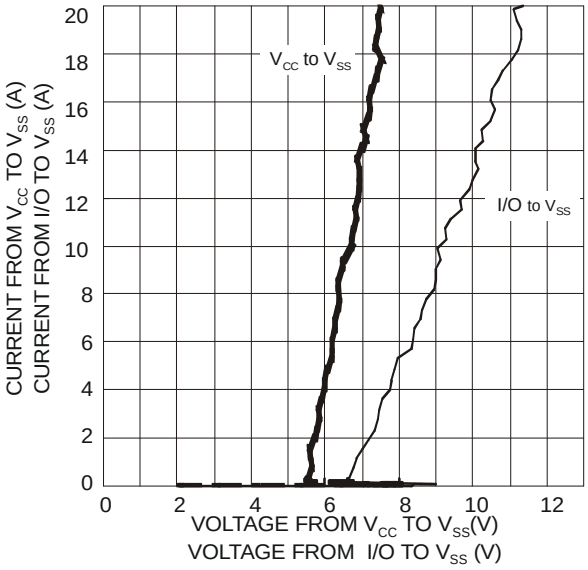
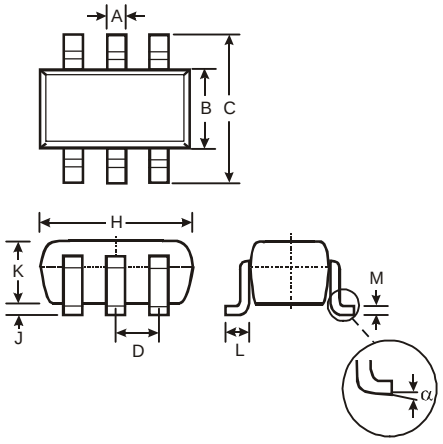


Figure 8. Current vs. Voltage

Package Outline Dimensions

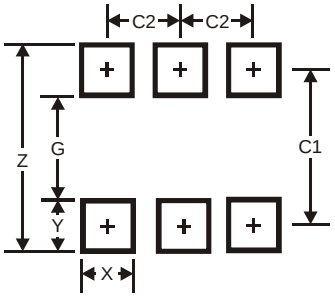
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT26			
Dim	**Min**	**Max**	**Typ**
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

www.diodes.com

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- View DT1042-04SO-7 on WIN SOURCE
- Diodes Incorporated Information

Optimize Your Supply Chain with WIN SOURCE Solutions

- Global Sourcing Solution
- Obsolete Management
- Cost Control Management
- Shortage Management
- Alternative Solution
- Excess Inventory Management